



Product Change Notification

Change Notification #: 115525 - 00
Change Title: Select Intel® Optane™ Memory Series Products, PCN 115525-00, Product Design, Label, Firmware and Label Update

Date of Publication: May 23, 2017

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	June 07, 2017
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Description of Change to the Customer:

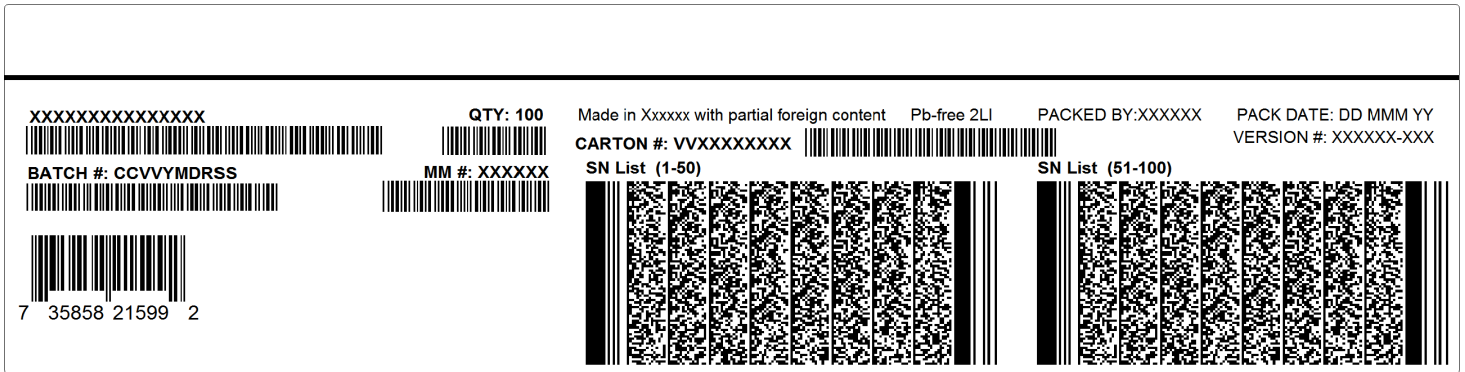
Intel® Optane™ Memory Series firmware version is being updated from K3110300 to K3110310. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

These Intel® Optane™ Memory Series products will also undergo the following label change:

Current Label

XXXXXXXXXXXXXXXXXX 	QTY: XXX 	MM #: XXXXXX 
CARTON #: XXXXXXXXXXXX 		
BATCH #: XXXXXXXXXXXX 		
VERSION #: XXXXXX-XXX 		
PACK DATE: XX XXX XX 		
PACKED BY: XXXXXXXX		
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT		 7 3585812345 7
		Pb-free

New Label



Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

The change in labeling only affects the label. There is no form, fit, function or visible change to the products listed in the Products Affected/Intel Order Codes table.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® Optane™ Memory Series (16GB, M.2 80mm PCIe 3.0, 20nm, 3D Xpoint) Generic Single Pack	MEMPEK1W016GA01	953340	J45694-100	J45811-101	J45694-101	J45811-102
Intel® Optane™ Memory Series (32GB, M.2 80mm PCIe 3.0, 20nm, 3D Xpoint) Generic Single Pack	MEMPEK1W032GA01	953341	J45695-100	J45812-101	J45695-101	J45812-102
Intel® Optane™ Memory Series (16GB, M.2 80mm PCIe 3.0, 20nm, 3D Xpoint) Retail Box 10pk	MEMPEK1W016GAXT	957790	J57060-100	J45811-101	J57060-101	J45811-102
Intel® Optane™ Memory Series (32GB, M.2 80mm PCIe 3.0, 20nm, 3D Xpoint) Retail Box 10pk	MEMPEK1W032GAXT	957793	J57061-100	J45812-101	J57061-101	J45812-102
Intel® Optane™ Memory Series (16GB, M.2 80mm PCIe 3.0, 20nm, 3D Xpoint) Generic 100pk	MEMPEK1W016GA	957794	J57062-100	J45811-101	J57062-101	J45811-102
Intel® Optane™ Memory Series (16GB, M.2 80mm PCIe 3.0, 20nm, 3D Xpoint) Generic 100pk	MEMPEK1W032GA	957795	J57063-100	J45812-101	J57063-101	J45812-102

PCN Revision History:

Date of Revision:

May 23, 2017

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

115525 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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